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APPLICATION NO.	FIL	ING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/825,612	0-	4/03/2001	Sujit Sharan	95-0716.01 3507		
7	590	09/11/2002				
Charles Brant	ley		EXAMINER			
Micron Technology, Inc. 8000 S. Federal Way				KILDAY, LISA A		
Mail Stop 525 Boise, ID 83716				ART UNIT	PAPER NUMBER	
20100, 12 00 1	•			2829	2829	
				DATE MAILED: 09/11/2002		

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
•" Office Action Summary	09/825,612	SHARAN ET AL.				
Office Action Summary	Examiner	Art Unit				
The MAILING DATE of this communication app	Lisa A Kilday	2829 ·				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). Status						
1) Responsive to communication(s) filed on <u>amer</u>	ndment and TD filed on 6/11/02	· ·				
	s action is non-final.	• '				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims						
4)⊠ Claim(s) <u>13-18,22-26 and 28</u> is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>13-18,22-26 and 28</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/or	election requirement.					
Application Papers						
9) The specification is objected to by the Examiner.						
10) The drawing(s) filed on is/are: a) accept	•					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a). 11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12) The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:						
1. Certified copies of the priority documents	have been received					
2. Certified copies of the priority documents		tion No				
3. Copies of the certified copies of the priority documents have been received in this National Stage						
application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
 a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 						
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informal	ry (PTO-413) Paper No(s) Patent Application (PTO-152)				

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Response to Arguments

Applicant's arguments with respect to claims 13-18, 22-26, 28 have been considered but are most in view of the new ground(s) of rejection.

Terminal Disclaimer

The terminal disclaimer filed on 6/11/02 disclaiming the terminal portion of any patent granted on this application which would extend beyond the expiration date of 5,946,594 has been reviewed and is accepted. The terminal disclaimer has been recorded.

Claim Rejections - 35 USC § 102

(e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

Claims 13-15 are rejected under 35 U.S.C. 102(e) as being anticipated by Chang (6,294,466). In re claim 13, Chang discloses in fig. 1 a method of making a semiconductor device, comprising the steps of: forming a product in a PECVD chamber (36) through an interaction of a chemically inert charged species producer gas (col. 11 lines 31-32, ref. 100d) and a metal-containing compound (col. 11 lines 33-36, ref. 100a) in a plasma (col. 11 lines 42-44) and exposing a substrate (54) to said product.

In re claim 14, Chang discloses wherein said step of forming a product comprises forming a product free of constituents of said chemically inert charged species producer gas (col. 11 lines 51-53).

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In re claim 15, Chang discloses wherein said step of exposing a substrate to said product further comprises forming a metal layer free of constituents of said chemically inert charged species producer gas (col. 11 lines 51-53).

In re claim 22, Chang discloses a method of performing a back-end-of-the line process comprising: providing a semiconductive device (54) under fabrication; placing said device in a vacuum chamber (36); supplying a metal source gas (100a) and a chemically inert-excitation gas (100d) within said vacuum chamber; and interacting said metal source gas and said chemically inert gas (col. 11 lines 42-44).

In re claim 23, Chang discloses wherein said step of interacting comprises ignigiting a plasma (col. 1 lines 64-67).

In re claim 24, Chang discloses a making a semiconductor device using PECVD comprising: providing a semiconductor device (54) under fabrication; placing said device in a vacuum chamber (36); forming combined gases comprising a metal source gas (100a) with a chemically inert energy-transfer gas (100d); supplying said combined gases to said vacuum chamber; and igniting a plasma (col. 1 lines 64-67).

In re claim 25, Chang discloses wherein said step of igniting a plasma comprises interacting said combined gases (col. 1 lines 64-67).

In re claim 26, Chang discloses wherein said step of interacting said combined gases comprises producing a charged species (col. 1 lines 59-67 – col. 2 lines 1-8).

In re claim 28, Chang discloses a semiconductor processing method comprising the following steps: providing a semiconductor wafer (56); subjecting said wafer to PECVD conditions in a chamber (col. 1 lines 57-65); forming an ionized reactant

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species by interacting a metal source material (100a) with a chemically inert collider gas (100d) in said chamber (col. 2 lines 1-8); and forming a metal-containing layer on said wafer from said ionized reactant species (col. 14 lines 28-43).

Claims 16-18 are rejected under 35 U.S.C. 102(e) as being anticipated by Chang in view of Muller and Kamins, "Device Electronics for Integrated Circuits", John Wiley and Sons, pg. 102.

In re claims 16 & 17, Chang discloses wherein said step of forming a product further comprises forming a metal-containing ion of said metal-containing compound (col. 11 lines 51-53, col. 2 lines 1-8). The method of Chang interacts a chemically inert charged species producer gas and a metal-containing compound in a plasma, which is inherently forming a metal-containing ion and metal-free ion from said metal-containing compound (see Muller and Kamins, pg. 102).

In re claim 18, Chang discloses further comprising a step of introducing a reactant gas (col. 6 lines 27-28) to said metal-containing ion; and wherein said step of exposing a substrate to said product comprises exposing said substrate to said product and said reactant gas (col. 11 lines 29-40, col. 1 lines 57-65).

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Conclusion

Any inquiry of a general nature or relating to the status of this application should be directed to the Group Receptionist whose telephone number is (703) 308-0957. See MPEP 203.08.

Any inquiry concerning this communication from the examiner should be directed to Lisa Kilday whose telephone number is (703) 306-5728. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Sherry, can be reached on (703) 308-1680. The fax number for the group is (703) 305-3432. MPEP 502.01 contains instructions regarding procedures used in submitting responses by facsimile transmission.

Lisa Kilday

LAK

8/27/02

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